

## RZ/G2L SMARC SCIF/UART Level Shifter

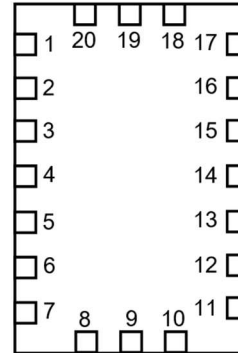
### General Description

Renesas SLG7RN45292 is a low power and small form device. The SoC is housed in a 2mm x 3mm STQFN package which is optimal for using with small devices.

### Features

- Low Power Consumption
- Pb - Free / RoHS Compliant
- Halogen - Free
- STQFN - 20 Package

### Pin Configuration



**STQFN-20  
(Top View)**

### Output Summary

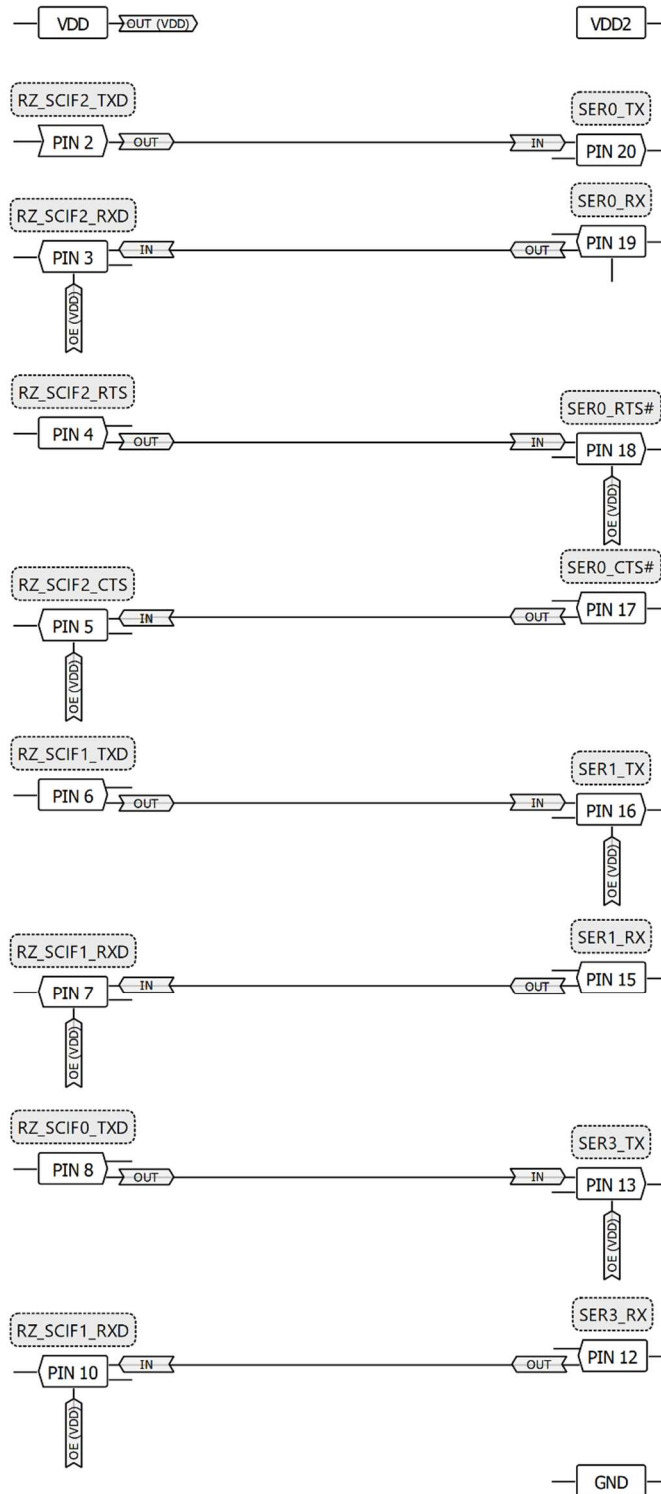
4 Outputs - Open Drain NMOS 1X  
4 Outputs - Push Pull 1X

### Pin name

Pin #	Pin name	Pin #	Pin name
1	VDD	11	GND
2	RZ_SCIF2_TXD	12	SER3_RX
3	RZ_SCIF2_RXD	13	SER3_TX
4	RZ_SCIF2_RTS	14	VDD2
5	RZ_SCIF2_CTS	15	SER1_RX
6	RZ_SCIF1_TXD	16	SER1_TX
7	RZ_SCIF1_RXD	17	SER0_CTS#
8	RZ_SCIF0_TXD	18	SER0_RTS#
9	NC	19	SER0_RX
10	RZ_SCIF1_RXD	20	SER0_TX

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Block Diagram



**RZ/G2L SMARC SCIF/UART Level Shifter**
**Pin Configuration**

Pin #	Pin Name	Type	Pin Description	Internal Resistor
1	VDD	PWR	Supply Voltage	--
2	RZ_SCIF2_TXD	Digital Input	Digital Input with Schmitt trigger	floating
3	RZ_SCIF2_RXD	Digital Output	Open Drain NMOS 1X	floating
4	RZ_SCIF2_RTS	Digital Input	Digital Input with Schmitt trigger	floating
5	RZ_SCIF2_CTS	Digital Output	Open Drain NMOS 1X	floating
6	RZ_SCIF1_TXD	Digital Input	Digital Input with Schmitt trigger	floating
7	RZ_SCIF1_RXD	Digital Output	Open Drain NMOS 1X	floating
8	RZ_SCIF0_TXD	Digital Input	Digital Input with Schmitt trigger	floating
9	NC	--	Keep Floating or Connect to GND	--
10	RZ_SCIF1_RXD	Digital Output	Open Drain NMOS 1X	floating
11	GND	GND	Ground	--
12	SER3_RX	Digital Input	Digital Input with Schmitt trigger	floating
13	SER3_TX	Digital Output	Push Pull 1X	floating
14	VDD2	PWR	Supply Voltage	--
15	SER1_RX	Digital Input	Digital Input with Schmitt trigger	floating
16	SER1_TX	Digital Output	Push Pull 1X	floating
17	SER0_CTS#	Digital Input	Digital Input with Schmitt trigger	floating
18	SER0_RTS#	Digital Output	Push Pull 1X	floating
19	SER0_RX	Digital Input	Digital Input with Schmitt trigger	floating
20	SER0_TX	Digital Output	Push Pull 1X	floating

**Ordering Information**

Part Number	Package Type
SLG7RN45292V	20-pin STQFN - Tape and Reel (3k units)

**RZ/G2L SMARC SCIF/UART Level Shifter**
**Absolute Maximum Conditions**

Parameter		Min.	Max.	Unit
Supply Voltage on VDD relative to GND		-0.5	7	V
Supply voltage on VDD2 relative to GND		-0.5	VDD + 0.5	V
DC Input voltage	PINs 2, 3, 4, 5, 6, 7, 8, 9, 10	GND - 0.5	VDD + 0.5	V
	PINs 12, 13, 15, 16, 17, 18, 19, 20		VDD2 + 0.5	
Maximum Average or DC Current (Through pin)	Push-Pull 1x	--	11	mA
	OD 1x	--	11	
Current at Input Pin		-1.0	1.0	mA
Input leakage (Absolute Value)		--	1000	nA
Storage Temperature Range		-65	150	°C
Junction Temperature		--	150	°C
ESD Protection (Human Body Model)		2000	--	V
ESD Protection (Charged Device Model)		500	--	V
Moisture Sensitivity Level		1		

**Electrical Characteristics**

Symbol	Parameter	Condition/Note	Min.	Typ.	Max.	Unit
V <sub>DD</sub>	Supply Voltage		4.7	5	5.5	V
V <sub>DD2</sub>	Supply Voltage		1.71	1.8	5.5	V
T <sub>A</sub>	Operating Temperature		-40	25	85	°C
C <sub>VDD</sub>	Capacitor Value at VDD		--	0.1	--	μF
C <sub>IN</sub>	Input Capacitance		--	4	--	pF
I <sub>Q</sub>	Quiescent Current	Static inputs and floating outputs	--	1.0	--	μA
V <sub>O</sub>	Maximal Voltage Applied to any PIN in High-Impedance State		--	--	VDD	V
I <sub>VDD</sub>	Maximum Average or DC Current Through VDD Pin (Per chip side, see Note 2)	T <sub>J</sub> = 85°C	--	--	45	mA
		T <sub>J</sub> = 110°C	--	--	22	mA
I <sub>GND</sub>	Maximum Average or DC Current Through GND Pin (Per chip side, see Note 2)	T <sub>J</sub> = 85°C	--	--	86	mA
		T <sub>J</sub> = 110°C	--	--	41	mA
V <sub>IH</sub>	HIGH-Level Input Voltage PINs 2, 3, 4, 5, 6, 7, 8, 9 and 10	Logic Input with Schmitt Trigger at VDD=5.0V	3.34	--	VDD	V
V <sub>IH2</sub>	HIGH-Level Input Voltage PINs 12, 13, 15, 16, 17, 18, 19, 20	Logic Input with Schmitt Trigger at VDD2=1.8V	1.28	--	VDD	V
		Logic Input with Schmitt Trigger at VDD2=3.3V	2.14	--	VDD	V
		Logic Input with Schmitt Trigger at VDD2=5.0V	3.34	--	VDD	V
V <sub>IL</sub>	LOW-Level Input Voltage PINs 2, 3, 4, 5, 6, 7, 8, 9 and 10	Logic Input with Schmitt Trigger at VDD=5.0V	0	--	1.41	V
V <sub>IL2</sub>	LOW-Level Input Voltage PINs 12, 13, 15, 16, 17, 18, 19, 20	Logic Input with Schmitt Trigger at VDD2=1.8V	0	--	0.49	V
		Logic Input with Schmitt Trigger at VDD2=3.3V	0	--	0.97	V
		Logic Input with Schmitt Trigger at VDD2=5.0V	0	--	1.41	V

**RZ/G2L SMARC SCIF/UART Level Shifter**

V <sub>OH2</sub>	HIGH-Level Output Voltage PINs 12, 13, 15, 16, 17, 18, 19, 20	Push-Pull 1X, I <sub>OH</sub> =100μA at VDD2=1.8V	1.69	1.79	--	V
		Push-Pull 1X, I <sub>OH</sub> =3mA at VDD2=3.3V	2.74	3.12	--	V
		Push-Pull 1X, I <sub>OH</sub> =5mA at VDD2=5.0V	4.15	4.76	--	V
V <sub>OL</sub>	LOW-Level Output Voltage PINs 2, 3, 4, 5, 6, 7, 8, 9 and 10	Open Drain NMOS 1X, I <sub>OL</sub> =5mA at VDD=5.0V	--	0.12	0.16	V
V <sub>OL2</sub>	LOW-Level Output Voltage PINs 12, 13, 15, 16, 17, 18, 19, 20	Push-Pull 1X, I <sub>OL</sub> =100μA at VDD2=1.8V	--	0.01	0.03	V
		Push-Pull 1X, I <sub>OL</sub> =3mA at VDD2=3.3V	--	0.13	0.23	V
		Push-Pull 1X, I <sub>OL</sub> =5mA at VDD2=5.0V	--	0.19	0.24	V
I <sub>OH2</sub>	HIGH-Level Output Current (see Note 1) PINs 12, 13, 15, 16, 17, 18, 19, 20	Push-Pull 1X, V <sub>OH</sub> =VDD-0.2V at VDD2=1.8V	1.07	1.70	--	mA
		Push-Pull 1X, V <sub>OH</sub> =2.4V at VDD2=3.3V	6.05	12.08	--	mA
		Push-Pull 1X, V <sub>OH</sub> =2.4V at VDD2=5.0V	22.08	34.04	--	mA
I <sub>OL</sub>	LOW-Level Output Current (see Note 1) PINs 2, 3, 4, 5, 6, 7, 8, 9 and 10	Open Drain NMOS 1X, V <sub>OL</sub> =0.4V at VDD=5.0V	10.82	17.38	--	mA
I <sub>OL2</sub>	LOW-Level Output Current (see Note 1) PINs 12, 13, 15, 16, 17, 18, 19, 20	Push-Pull 1X, V <sub>OL</sub> =0.15V at VDD2=1.8V	0.92	1.69	--	mA
		Push-Pull 1X, V <sub>OL</sub> =0.4V at VDD2=3.3V	4.88	8.24	--	mA
		Push-Pull 1X, V <sub>OL</sub> =0.4V at VDD2=5.0V	7.22	11.58	--	mA
T <sub>SU</sub>	Startup Time	From VDD rising past P <sub>ON</sub> <sub>THR</sub>	0.61	1.24	1.65	ms
P <sub>ON</sub> <sub>THR</sub>	Power On Threshold	V <sub>DD</sub> Level Required to Start Up the Chip	1.41	1.54	1.66	V
P <sub>OFF</sub> <sub>THR</sub>	Power Off Threshold	V <sub>DD</sub> Level Required to Switch Off the Chip	1.00	1.15	1.31	V

**Note:**

- DC or average current through any pin should not exceed value given in Absolute Maximum Conditions.
- The GreenPAK's power rails are divided in two sides. PINs 2, 3, 4, 5, 6, 7, 8, 9 and 10 are connected to one side, PINs 12, 13, 15, 16, 17, 18, 19, and 20 to another.
- Guaranteed by Design.

# RZ/G2L SMARC SCIF/UART Level Shifter

## Functionality Waveforms

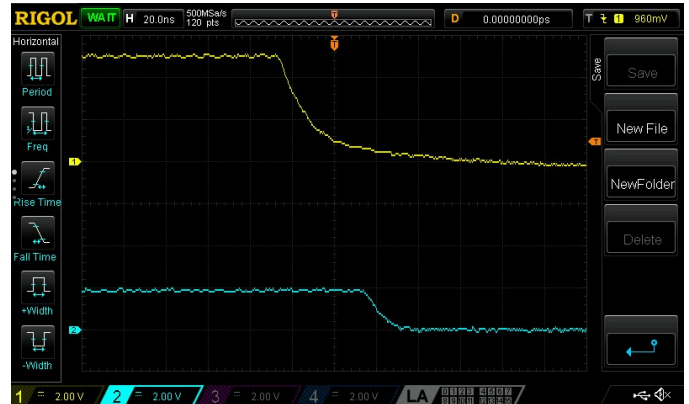
Channel 1 (yellow/top line) – PIN# 2 (RZ\_SCIF2\_TXD)

Channel 2 (light blue/2nd line) – PIN# 20 (SER0\_TX)

1. Transient from Low to High  
(PIN# 2 (RZ\_SCIF2\_TXD) => PIN# 20 (SER0\_TX))



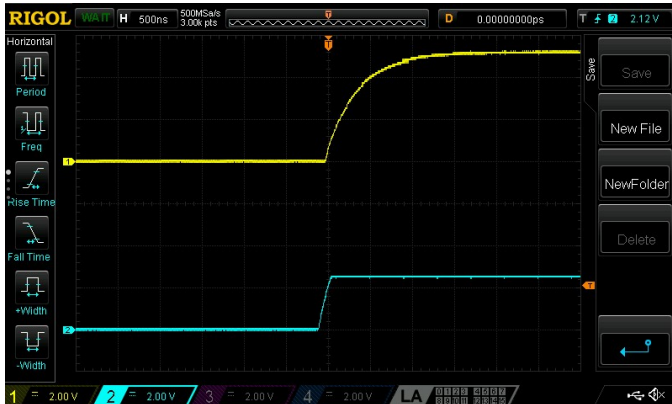
2. Transient from High to Low  
(PIN# 2 (RZ\_SCIF2\_TXD) => PIN# 20 (SER0\_TX))



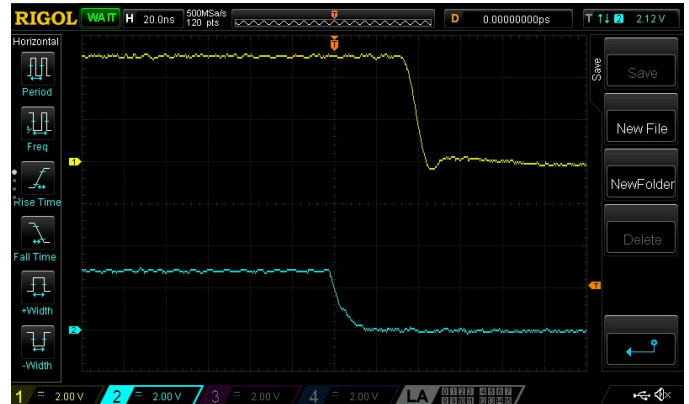
Channel 1 (yellow/top line) – PIN# 3 (RZ\_SCIF2\_RXD) with external 5kΩ pull up resistor

Channel 2 (light blue/2nd line) – PIN# 19 (SER0\_RX)

3. Transient from Low to High  
(PIN# 19 (SER0\_RX) => PIN# 3 (RZ\_SCIF2\_RXD))



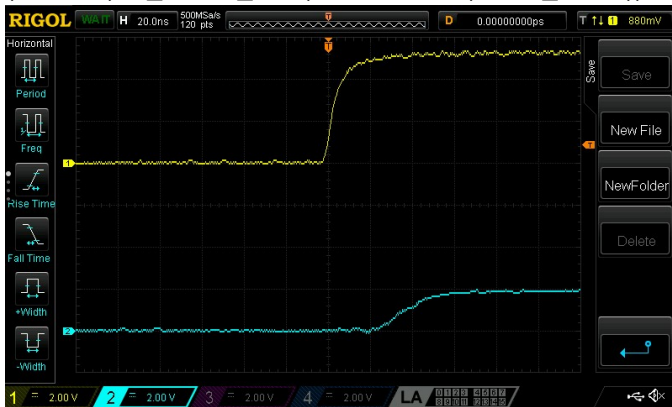
4. Transient from High to Low  
(PIN# 19 (SER0\_RX) => PIN# 3 (RZ\_SCIF2\_RXD))



### RZ/G2L SMARC SCIF/UART Level Shifter

Channel 1 (yellow/top line) – PIN# 4 (RZ\_SCIF2\_RTS)  
 Channel 2 (light blue/2nd line) – PIN# 18 (SER0\_RTS#)

5. Transient from Low to High  
 (PIN# 4 (RZ\_SCIF2\_RTS) => PIN# 18 (SER0\_RTS#))



6. Transient from High to Low  
 (PIN# 4 (RZ\_SCIF2\_RTS) => PIN# 18 (SER0\_RTS#))



Channel 1 (yellow/top line) – PIN# 5 (RZ\_SCIF2\_CTS) with external 5kΩ pull up resistor  
 Channel 2 (light blue/2nd line) – PIN# 17 (SER0\_CTS#)

7. Transient from Low to High  
 (PIN# 17 (SER0\_CTS#) => PIN# 5 (RZ\_SCIF2\_CTS))



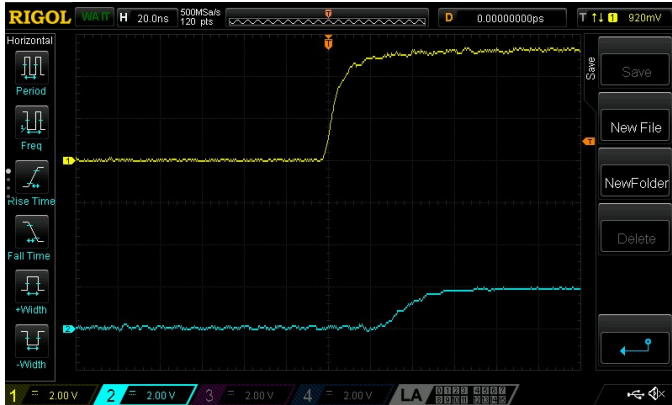
8. Transient from High to Low  
 (PIN# 17 (SER0\_CTS#) => PIN# 5 (RZ\_SCIF2\_CTS))



### RZ/G2L SMARC SCIF/UART Level Shifter

Channel 1 (yellow/top line) – PIN# 6 (RZ\_SCIF1\_TXD)  
 Channel 2 (light blue/2nd line) – PIN# 16 (SER1\_TX)

9. Transient from Low to High (PIN# 6 (RZ\_SCIF1\_TXD) => PIN# 16 (SER1\_TX))



10. Transient from High to Low (PIN# 6 (RZ\_SCIF1\_TXD) => PIN# 16 (SER1\_TX))



Channel 1 (yellow/top line) – PIN# 7 (RZ\_SCIF1\_RXD) with external 5kΩ pull up resistor  
 Channel 2 (light blue/2nd line) – PIN# 15 (SER1\_RX)

11. Transient from Low to High (PIN# 15 (SER1\_RX) => PIN# 7 (RZ\_SCIF1\_RXD))



12. Transient from High to Low (PIN# 15 (SER1\_RX) => PIN# 7 (RZ\_SCIF1\_RXD))

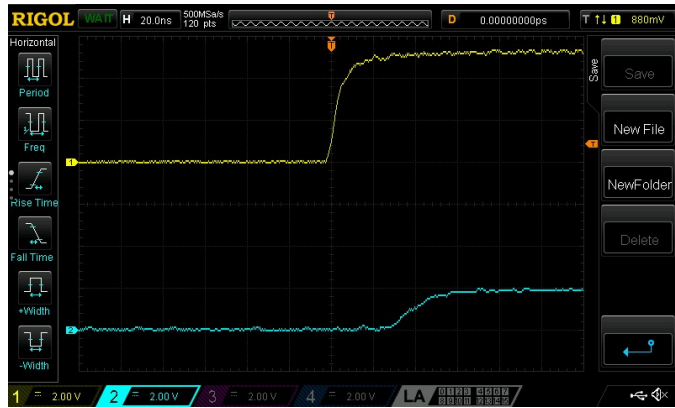




### RZ/G2L SMARC SCIF/UART Level Shifter

Channel 1 (yellow/top line) – PIN# 8 (RZ\_SCIF0\_TXD)  
 Channel 2 (light blue/2nd line) – PIN# 13 (SER3\_TX)

13. Transient from Low to High  
 (PIN# 8 (RZ\_SCIF0\_TXD) => PIN# 13 (SER3\_TX))



14. Transient from High to Low  
 (PIN# 8 (RZ\_SCIF0\_TXD) => PIN# 13 (SER3\_TX))

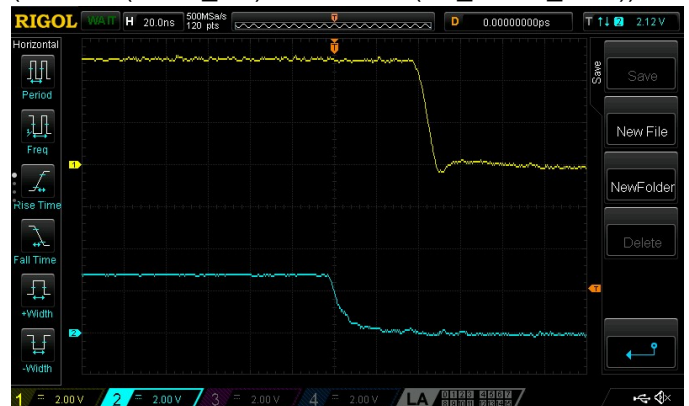


Channel 1 (yellow/top line) – PIN# 10 (RZ\_SCIF1\_RXD) with external 5kΩ pull up resistor  
 Channel 2 (light blue/2nd line) – PIN# 12 (SER3\_RX)

15. Transient from Low to High  
 (PIN# 12 (SER3\_RX) => PIN# 10 (RZ\_SCIF1\_RXD))

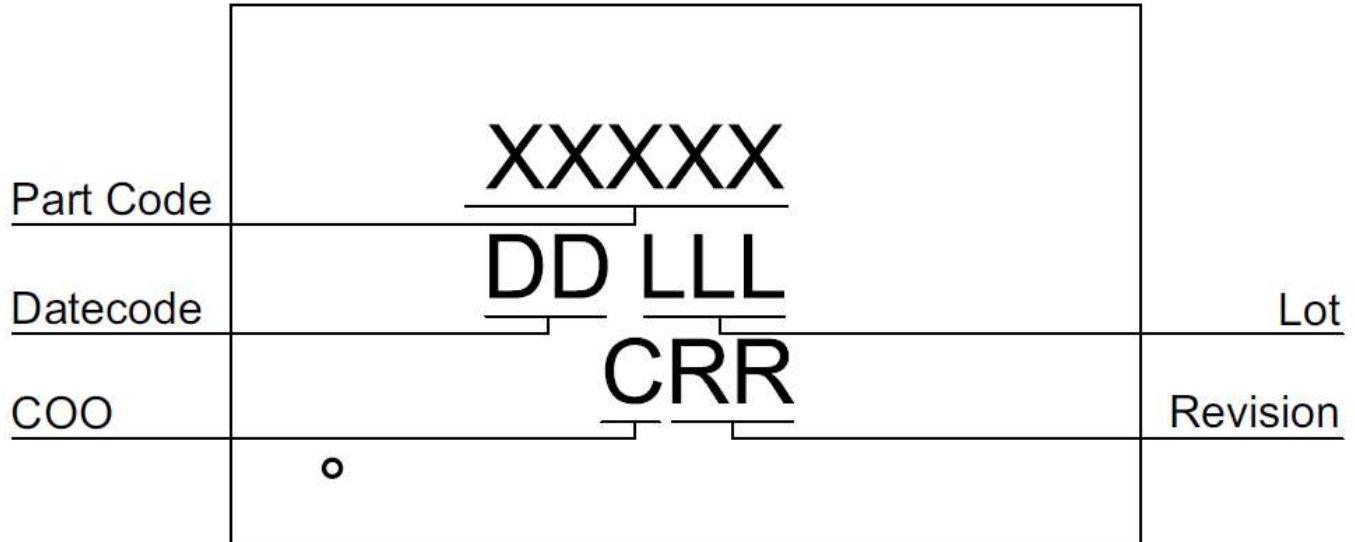


16. Transient from High to Low  
 (PIN# 12 (SER3\_RX) => PIN# 10 (RZ\_SCIF1\_RXD))



### RZ/G2L SMARC SCIF/UART Level Shifter

#### Package Top Marking



- XXXXX – Part ID Field: identifies the specific device configuration
- DD – Date Code Field: Coded date of manufacture
- LLL – Lot Code: Designates Lot #
- C – Assembly Site/COO: Specifies Assembly Site/Country of Origin
- RR – Revision Code: Device Revision

Datasheet Revision	Programming Code Number	Lock Status	Checksum	Part Code	Revision	Date
0.12	001	U	0xCBf917F4	45292	AA	07/11/2023

Lock coverage for this part is indicated by  $\surd$ , from one of the following options:

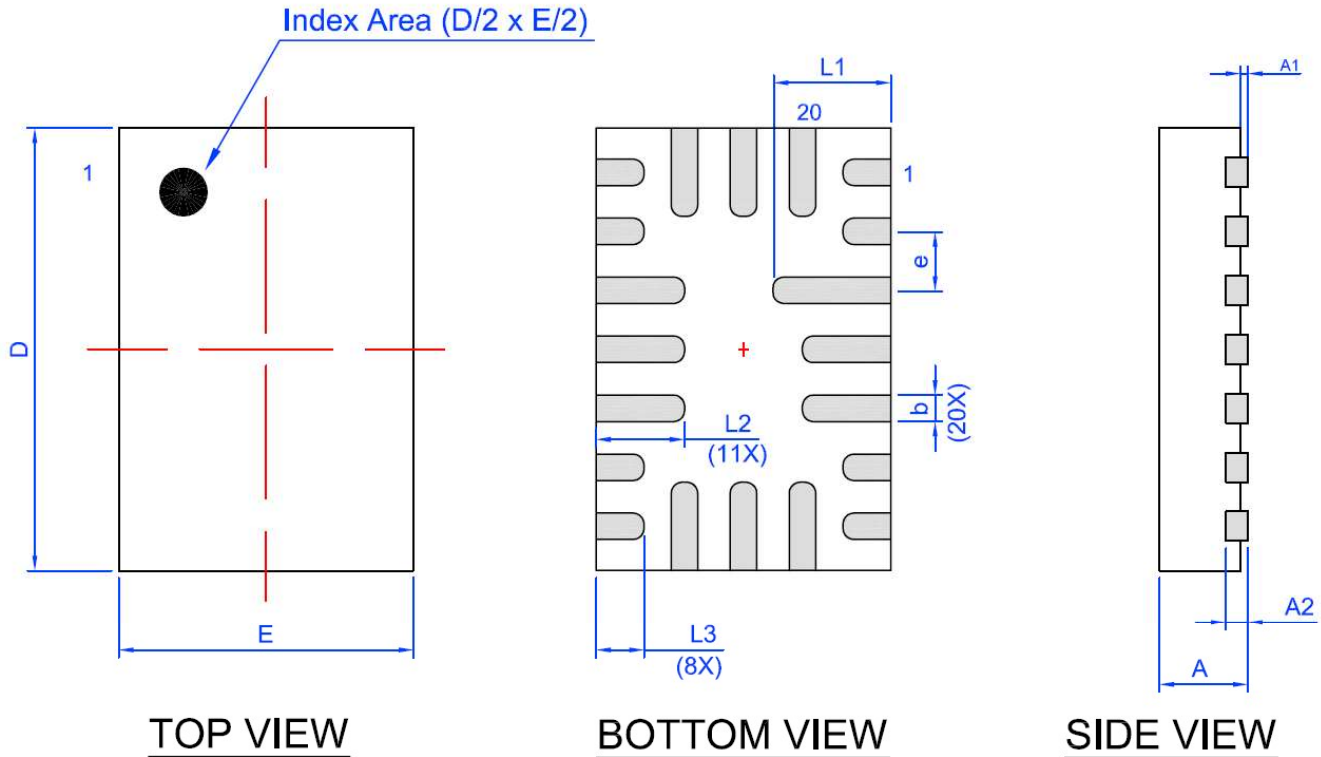
$\surd$	Unlocked
	Locked for read, bits <1535:0>
	Locked for write, bits <1535:0>
	Locked for write all bits
	Locked for read and write bits <1535:0>
	Locked for read bits <1535:0> and write of all bits

The IC security bit is locked/set for code security for production unless otherwise specified. The Programming Code Number is not changed based on the choice of locked vs. unlocked status.

### RZ/G2L SMARC SCIF/UART Level Shifter

#### Package Drawing and Dimensions

STQFN 20L 2x3mm 0.4P COL Package  
JEDEC MO-220



Unit: mm

Symbol	Min	Nom.	Max	Symbol	Min	Nom.	Max
A	0.50	0.55	0.60	D	2.95	3.00	3.05
A1	0.005	-	0.050	E	1.95	2.00	2.05
A2	0.10	0.15	0.20	L1	0.75	0.80	0.85
b	0.13	0.18	0.23	L2	0.55	0.60	0.65
e	0.40 BSC			L3	0.275	0.325	0.375

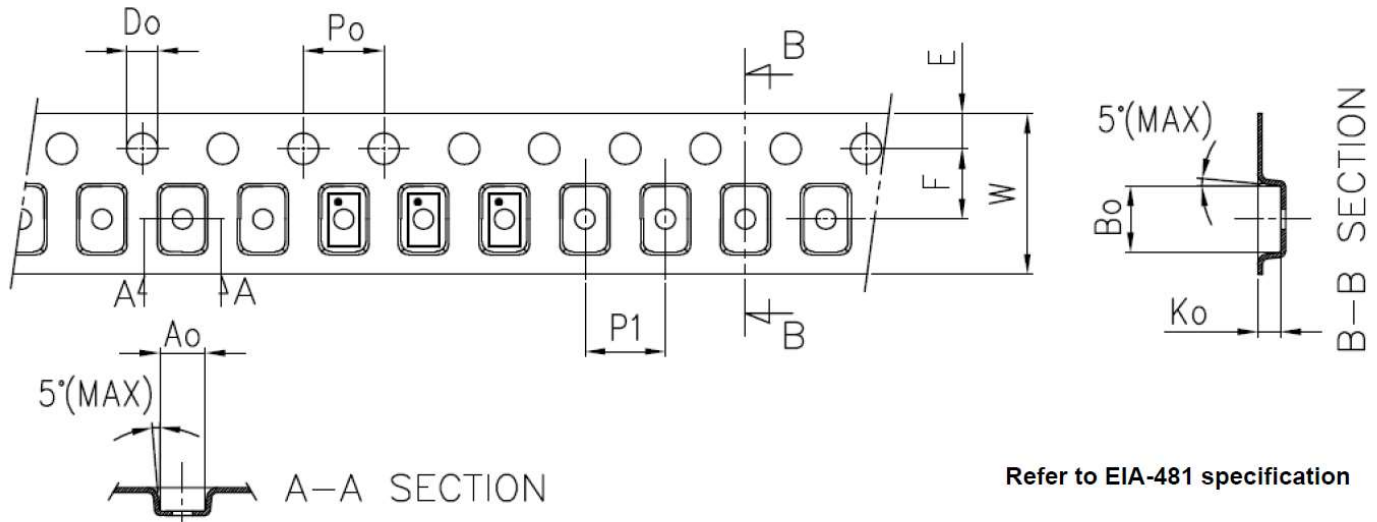
### RZ/G2L SMARC SCIF/UART Level Shifter

#### Tape and Reel Specification

Package Type	# of Pins	Nominal Package Size [mm]	Max Units		Reel & Hub Size [mm]	Leader (min)		Trailer (min)		Tape Width [mm]	Part Pitch [mm]
			per Reel	per Box		Pockets	Length [mm]	Pockets	Length [mm]		
STQFN 20L 2x3mm 0.4P COL	20	2x3x0.55	3000	3000	178/60	100	400	100	400	8	4

#### Carrier Tape Drawing and Dimensions

Package Type	Pocket BTM Length	Pocket BTM Width	Pocket Depth	Index Hole Pitch	Pocket Pitch	Index Hole Diameter	Index Hole to Tape Edge	Index Hole to Pocket Center	Tape Width
	A0	B0	K0	P0	P1	D0	E	F	W
STQFN 20L 2x3 mm 0.4P COL	2.2	3.15	0.76	4	4	1.5	1.75	3.5	8




#### Recommended Reflow Soldering Profile

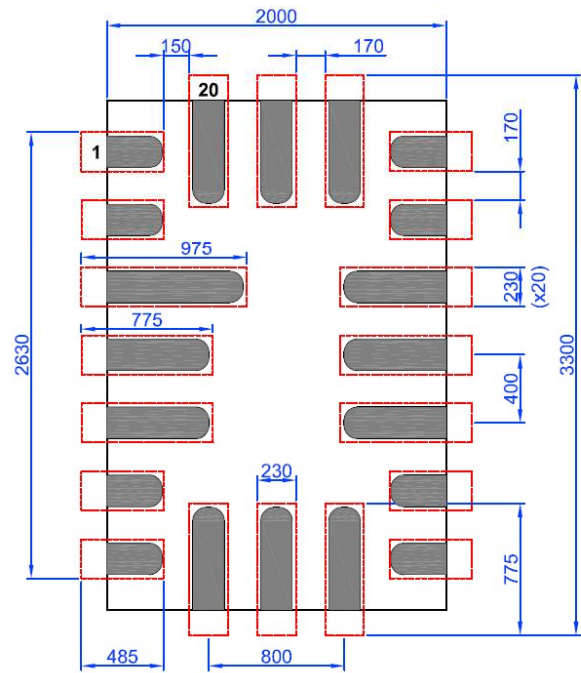
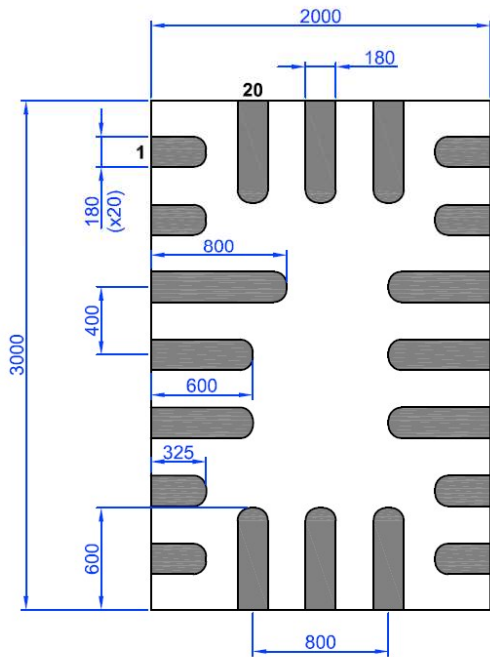
Please see IPC/JEDEC J-STD-020: latest revision for reflow profile based on package volume of 3.30 mm<sup>3</sup> (nominal). More information can be found at [www.jedec.org](http://www.jedec.org).

#### Recommended Land Pattern

 Exposed Pad  
(Top View)

 Recommended Land Pattern  
(Top View)

Units:  $\mu\text{m}$



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**Datasheet Revision History**

Date	Version	Change
10/07/2021	0.10	New design for SLG46538V chip
11/04/2021	0.11	Updated DRS Table
07/11/2023	0.12	Moved to Renesas template

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